

NTJD4401NT1G-VB Datasheet

Dual N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
	0.086 at $V_{GS} = 4.5 \text{ V}$	2.6 ^a				
20	0.110 at V _{GS} = 2.5 V	2.5 ^a	5.0 nC			
	0.180 at V _{GS} = 1.8 V	2.3 ^a				

FEATURES

Halogen-free According to IEC 61249-2-21 **Definition**



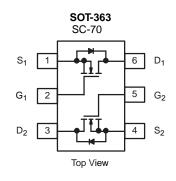
Trench Power MOSFET 100 % R_g Tested

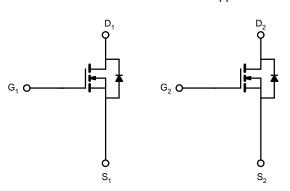
• Compliant to RoHS Directive 2002/95/EC

COMPLIANT

APPLICATIONS

· Load Switch for Portable Applications





ABSOLUTE MAXIMUM RATINGS	S (T _A = 25 °C, unle	ess otherwise no	ted)		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	20	V		
Gate-Source Voltage		V_{GS}	± 12	v	
	T _C = 25 °C		2.6 ^a		
Continuous Desir Comment (T., 450 °C)	T _C = 70 °C		2.2 ^a		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	2.3 ^{a, b, c}		
	T _A = 70 °C		1.8 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	8		
0 0 0	T _C = 25 °C	1	2.3		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.10 ^{b, c}		
	T _C = 25 °C		2.70		
Maximum Power Dissipation	T _C = 70 °C		1.70	10/	
	T _A = 25 °C	P _D	1.5 ^{b, c}	W	
	T _A = 70 °C		1.0 ^{b, c}		
Operating Junction and Storage Temperature Ra	T _{.I} , T _{sta}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	130	170	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	80	100	- 0///		

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- d. Maximum under steady state conditions is 220 °C/W.



Parameter	Symbol	Test Conditions	Min.	Min. Typ.		Unit	
Static						•	
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$	20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 250 A		20		~\\/°C	
$V_{GS(th)}$ Temperature Coefficient $\Delta V_{GS(th)}$		$I_D = 250 \mu\text{A}$		- 2.3		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.5		2.0	V	
Gate-Source Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 25	μA	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			1		
Zero Gate Voltage Drain Current		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Brain Gunerit	I _{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	4			Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 1 \text{ A}$		0.086			
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 1 \text{ A}$		0.110		Ω	
		$V_{GS} = 1.8 \text{ V}, I_D = 0.2 \text{ A}$		0.180]	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 4 \text{ V}, I_{D} = 1.5 \text{ A}$		4		S	
Dynamic ^b							
Total Gate Charge	Q_g	$V_{DS} = 10 \text{ V}, V_{GS} = 8 \text{ V}, I_{D} = 1.5 \text{ A}$		5.0		nC	
Total Gate Charge				3.0			
Gate-Source Charge	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 1.5 \text{ A}$		1.0			
Gate-Drain Charge	Q_{gd}			2.0			
Gate Resistance	R_{g}	f = 1 MHz	0.4	1.9	3.8	kΩ	
Turn-On Delay Time	t _{d(on)}			43	65		
Rise Time	t _r	V_{DD} = 10 V, R_L = 8.3 Ω		80	120	- ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1.2 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		480	720		
Fall Time	t _f			220	330		
Turn-on Delay Time	t _{d(on)}			22	33		
Rise Time	tr	V_{DD} = 10 V, R_L = 8.3 Ω		46	70		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1.2 \text{ A}, V_{GEN} = 8 \text{ V}, R_g = 1 \Omega$		645	968		
Fall Time	tr			215	323		
Drain-Source Body Diode Characteristic	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C		2.6		А	
Pulse Diode Forward Current	I _{SM}			4		A	
Body Diode Voltage	V_{SD}	I _S = 1.2 A, V _{GS} = 0 V		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			9	18	ns	
Body Diode Reverse Recovery Charge	Charge Q _{rr} I ₂ = 1.2 A dl/dt = 100 A/us T ₂ = 2			2	4	nC	
Reverse Recovery Fall Time	t _a	$I_F = 1.2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °C$		5		20	
Reverse Recovery Rise Time	t _b			4		ns	

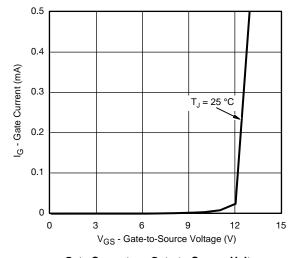
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

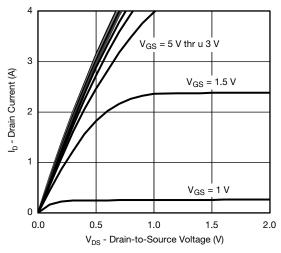
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



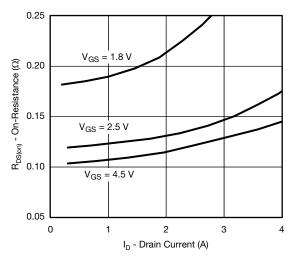
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



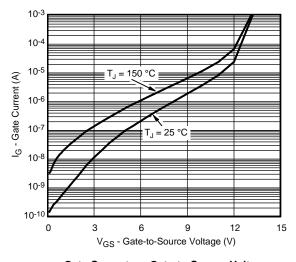
Gate Current vs. Gate-to-Source Voltage



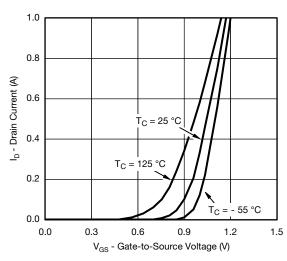
Output Characteristics



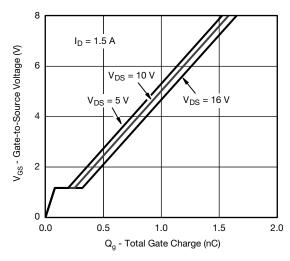
On-Resistance vs. Drain Current



Gate Current vs. Gate-to-Source Voltage



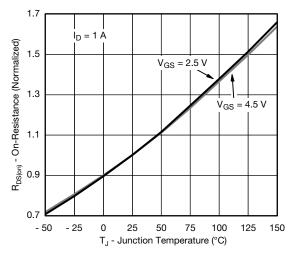
Transfer Characteristics



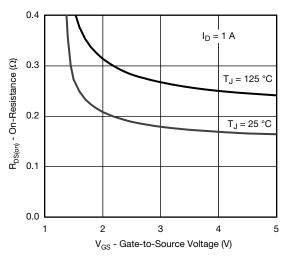
Gate Charge



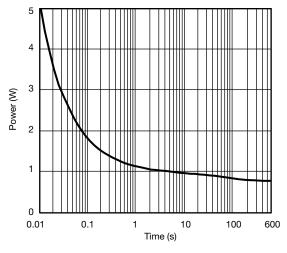
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



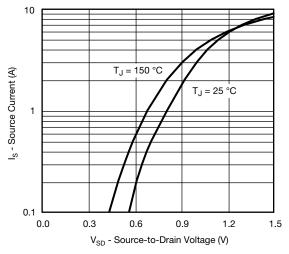
On-Resistance vs. Junction Temperature



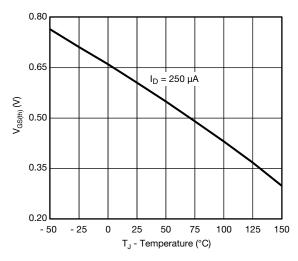
On-Resistance vs. Gate-to-Source Voltage



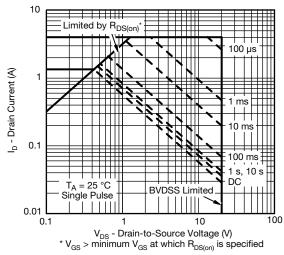
Single Pulse Power, Junction-to-Ambient



Source-Drain Diode Forward Voltage



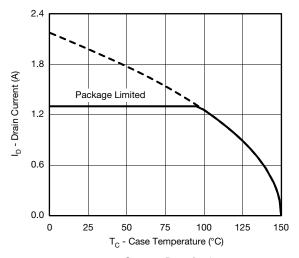
Threshold Voltage



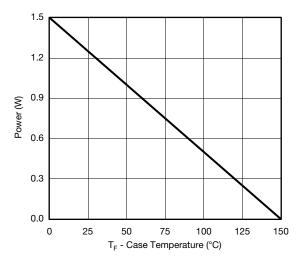
Safe Operating Area, Junction-to-Ambient



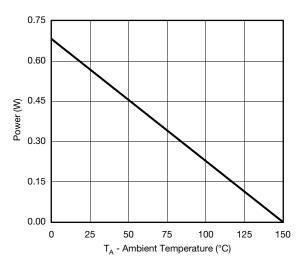
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*





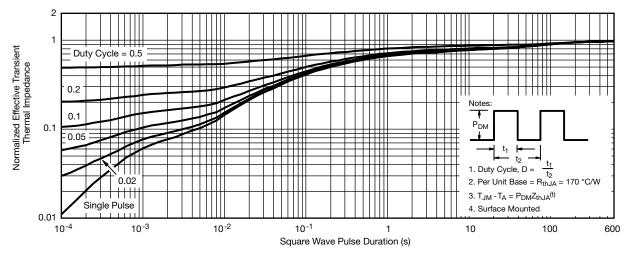


Power, Junction-to-Ambient

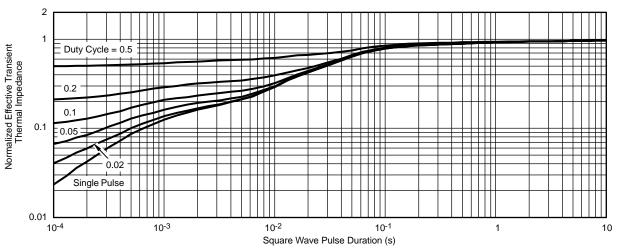
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 C, unless otherwise noted)



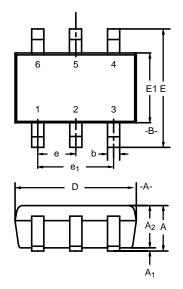
Normalized Thermal Transient Impedance, Junction-to-Ambient

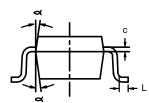


Normalized Thermal Transient Impedance, Junction-to-Foot



SC-70: 6-LEADS





	MILLIMETERS			INCHES		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.90	_	1.10	0.035	_	0.043
A_1	-	-	0.10	-	_	0.004
A ₂	0.80	_	1.00	0.031	_	0.039
b	0.15	-	0.30	0.006	_	0.012
С	0.10	_	0.25	0.004	-	0.010
D	1.80	2.00	2.20	0.071	0.079	0.087
Ε	1.80	2.10	2.40	0.071	0.083	0.094
E ₁	1.15	1.25	1.35	0.045	0.049	0.053
е	0.65BSC			C 0.026BSC		
e ₁	1.20	1.30	1.40	0.047	0.051	0.055
L	0.10	0.20	0.30	0.004	0.008	0.012
a	7°Nom			7°Nom		
				1		



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